

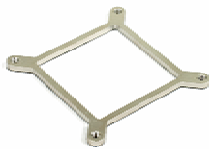
Thermaltake Mobile Solution Cooler

P/N : CL-P0281

Application for Intel Mobile Pentium
M/ Celeron M Solution
Intel Server Sossaman CPU



Spring Screw



Back Plate



All Aluminum
Extrusion Heatsink

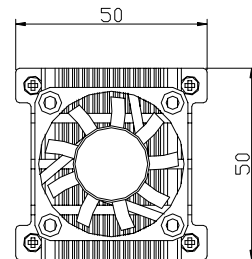
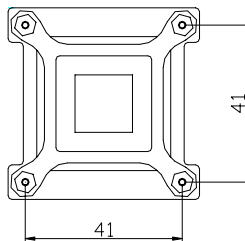
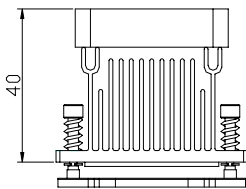
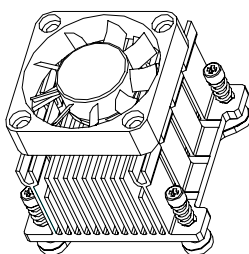
SPECIFICATION

Fan Dimension : 40X40X10mm
Heat Sink Dimension : 50x50x30mm
Heat Sink Material: Aluminum extrusion
Rated Voltage : 12V
Started Voltage : 7V
Fan Speed : 5500 RPM (Max.)
Rated Current: 0.12A (Max.)
Max. Air Flow: 4.25 CFM (Max.)
Max. Air Pressure: 2.41 mmH2O (Max.)
Bearing Type: 1 Ball 1 Sleeve
Noise Level: 25 dB (Max.)
Life Expectation: 40,000hrs
Connector : 3 Pins
Weight: 97g

Features

All Aluminum extrusion heatsink.
Back plate w/ spring screw
Used for low-voltage CPU
SC-102 provides good contact with heat
source

DIMENSION



Unit: mm